

# **Rochester Electronics Manufactured Components**

Rochester branded components are manufactured using either die/wafers purchased from the original suppliers or Rochester wafers recreated from the original IP. All recreations are done with the approval of the OCM.

Parts are tested using original factory test programs or Rochester developed test solutions to guarantee product meets or exceed the OCM data sheet.

# **Quality Overview**

- ISO-9001
- AS9120 certification
- Qualified Manufacturers List (QML) MIL-PRF-35835
  - Class Q Military
  - Class V Space Level
- Qualified Suppliers List of Distributors (QSLD)

• Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OEM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.



## 54F/74F32 Quad 2-Input OR Gate

## **General Description**

### Features

This device contains four independent gates, each of which performs the logic OR function.

Guaranteed 4000V minimum ESD protection

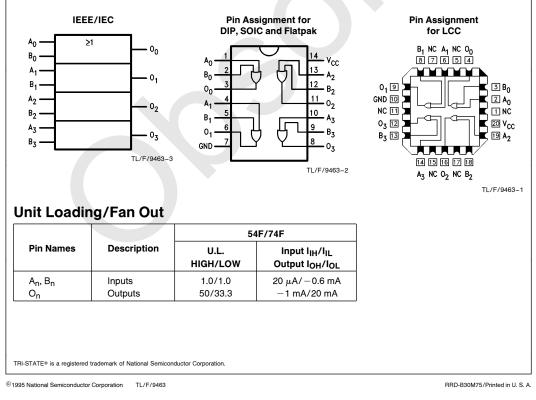
Commercial	Military	Package Number	Package Description		
74F32PC		N14A	14-Lead (0.300" Wide) Molded Dual-In-Line		
	54F32DM (Note 2)	J14A	14-Lead Ceramic Dual-In-Line		
74F32SC (Note 1)		M14A	14-Lead (0.150" Wide) Molded Small Outline, JEDEC		
74F32SJ (Note 1)		M14D	14-Lead (0.300" Wide) Molded Small Outline, EIAJ		
	54F32FM (Note 2)	W14B	14-Lead Cerpack		
	54F32LM (Note 2)	E20A	20-Lead Ceramic Leadless Chip Carrier, Type C		

Note 1: Devices also available in 13" reel. Use suffix = SCX and SJX.

Note 2: Military grade device with environmental and burn-in processing. Use suffix = DMQB, FMQB and LMQB.

## Logic Symbol

## **Connection Diagrams**



# 54F/74F32 Quad 2-Input OR Gate

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## Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Storage Temperature	-65°C to +150°C
Ambient Temperature under Bias	-55°C to +125°C
Junction Temperature under Bias Plastic	−55°C to +175°C −55°C to +150°C
V <sub>CC</sub> Pin Potential to Ground Pin	-0.5V to +7.0V
Input Voltage (Note 2)	-0.5V to +7.0V
Input Current (Note 2)	-30 mA to $+5.0$ mA
Voltage Applied to Output in HIGH State (with V <sub>CC</sub> = 0V)	
Standard Output	-0.5V to V <sub>CC</sub>
TRI-STATE <sup>®</sup> Output	-0.5V to +5.5V
Current Applied to Output	
in LOW State (Max)	twice the rated I <sub>OL</sub> (mA)
ESD Last Passing Voltage (Min)	4000V
Note 1: Absolute maximum ratings are value	

# Recommended Operating Conditions

## Free Air Ambient Temperature

Military	-55°C to +125°C
Commercial	0°C to +70°C
Supply Voltage	
Military	+ 4.5V to + 5.5V
Commercial	+ 4.5V to + 5.5V

be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

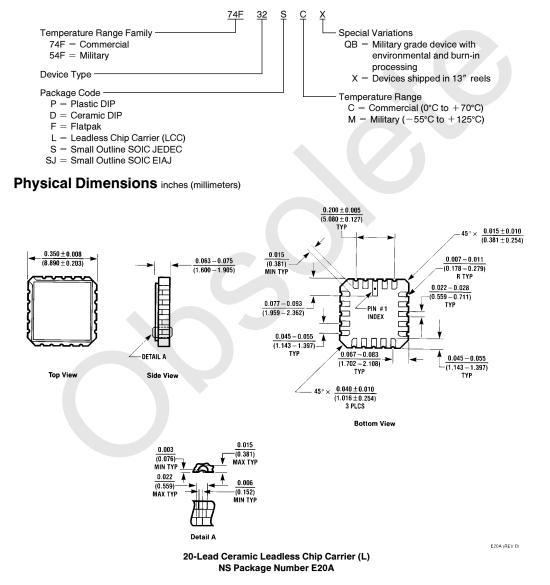
## **DC Electrical Characteristics**

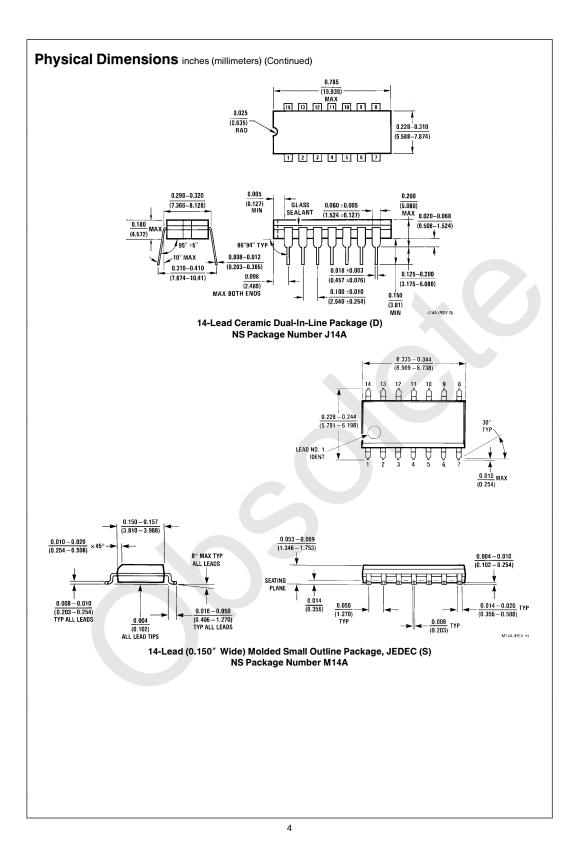
Symbol	Parameter		54F/74F			Units	Vcc	Conditions	
Symbol			Min	Тур	Max	Units	VCC	Conditions	
VIH	Input HIGH Voltage		2.0			v		Recognized as a HIGH Signa	
VIL	Input LOW Voltage				0.8	V		Recognized as a LOW Signa	
V <sub>CD</sub>	Input Clamp Diode Vo	oltage			-1.2	v	Min	$I_{IN} = -18 \text{ mA}$	
V <sub>OH</sub>	Output HIGH Voltage	54F 10% V <sub>CC</sub> 74F 10% V <sub>CC</sub> 74F 5% V <sub>CC</sub>	2.5 2.5 2.7			v	Min	$I_{OH} = -1 \text{ mA}$ $I_{OH} = -1 \text{ mA}$ $I_{OH} = -1 \text{ mA}$	
V <sub>OL</sub>	Output LOW Voltage	54F 10% V <sub>CC</sub> 74F 10% V <sub>CC</sub>			0.5 0.5	V	Min	$I_{OL} = 20 \text{ mA}$ $I_{OL} = 20 \text{ mA}$	
Ι <sub>ΙΗ</sub>	Input HIGH Current	54F 74F			20.0 5.0	μΑ	Max	$V_{IN} = 2.7V$	
I <sub>BVI</sub>	Input HIGH Current Breakdown Test	54F 74F			100 7.0	μΑ	Max	V <sub>IN</sub> = 7.0V	
ICEX	Output HIGH Leakage Current	54F 74F			250 50	μΑ	Max	$V_{OUT} = V_{CC}$	
V <sub>ID</sub>	Input Leakage Test	74F	4.75			V	0.0	$I_{ID} = 1.9 \ \mu A$ All Other Pins Grounded	
I <sub>OD</sub>	Output Leakage Circuit Current	74F			3.75	μΑ	0.0	V <sub>IOD</sub> = 150 mV All Other Pins Grounded	
IIL	Input LOW Current				-0.6	mA	Max	$V_{IN} = 0.5V$	
l <sub>OS</sub>	Output Short-Circuit Current		-60		-150	mA	Max	$V_{OUT} = 0V$	
ICCH	Power Supply Current			6.1	9.2	mA	Max	V <sub>O</sub> = HIGH	
I <sub>CCL</sub>	Power Supply Current			10.3	15.5	mA	Max	$V_{O} = LOW$	

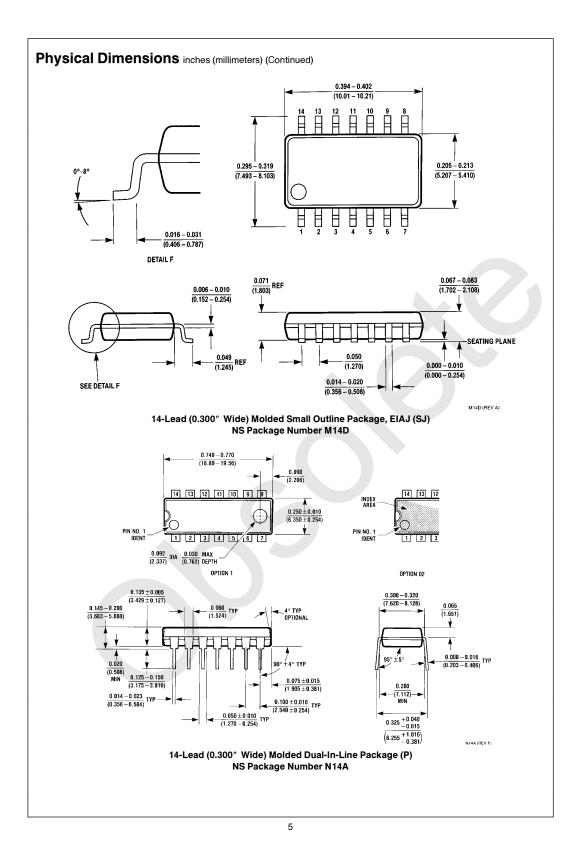
AC Electrical Characteristics										
		$74F \\ T_A = +25^{\circ}C \\ V_{CC} = +5.0V \\ C_L = 50 \text{ pF} $			5	4F	74F			
Symbol	Parameter				$\begin{array}{l} \textbf{T_{A}, V_{CC} = Mil} \\ \textbf{C_{L} = 50 pF} \end{array}$		$T_A, V_{CC} = Com$ $C_L = 50  pF$		Units	
		Min	Тур	Мах	Min	Max	Min	Мах		
t <sub>PLH</sub>	Propagation Delay	3.0	4.2	5.6	3.0	7.5	3.0	6.6	ns	
t <sub>PHL</sub>	A <sub>n</sub> , B <sub>n</sub> to O <sub>n</sub>	3.0	4.0	5.3	2.5	7.5	3.0	6.3	115	

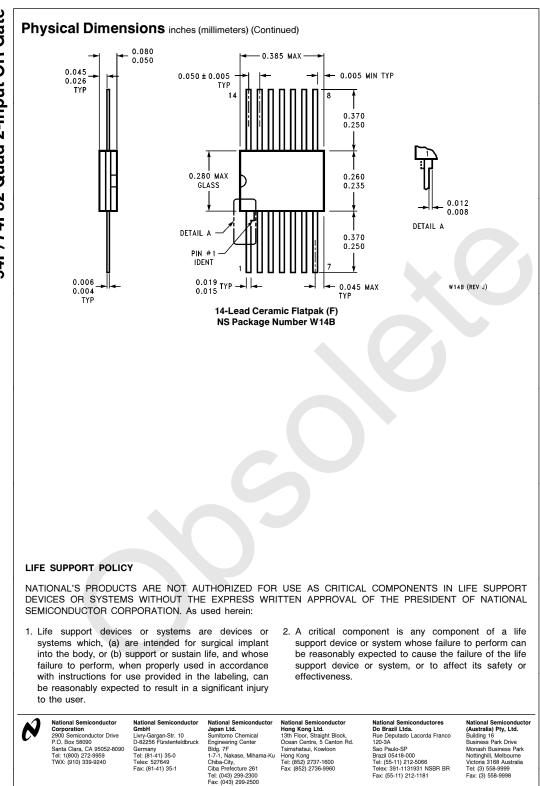
## **Ordering Information**

The device number is used to form part of a simplified purchasing code where the package type and temperature range are defined as follows:









National does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and National reserves the right at any time without notice to change said circuitry and specifications.